IPC ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES	Material Composit © Copyright 2005. IPC, international and Pan-An	Bannockb	urn, Illinois. A	ll rights reserved untions.		arts, the	is a declarat declaration	tion of the si encompasse	ubstances s all lowe	s within the manufact er level materials for	urer listed which the	item. Note: manufacture	if the item is an as r has engineering	sembly with lov responsibility.	
752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Ty http://www.ipc.org/IPC-175x Distribut				Form Type * Distribute	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materia					rials and I	als and Mfg Information			
Supplier Informa	ition														
Company name*			Company unique ID			Uni	Unique ID Authority					Response Date*			
onsemi												2023-06-08			
Contact Name			Title - Contact			Pho	Phone - Contact*					Email - Contact*			
Product-Env-Stewards			Product Enviro Compliance			NA	NA				Produ	Product-Env-Stewards@onsemi.com			
Authorized Representative*			Title - Representative			Pho	Phone - Representative*				Email	Email - Representative*			
Product-Env-Stewards			Product Enviro Compliance			NA	NA				Produ	Product-Env-Stewards@onsemi.com			
Requester	ester Item Number Mfr Item		n Number Mfr Item Name			Effective		e Version		Manufacturing Site		Weight*	UOM	Unit Type	
				driver with sensor	DRV SEN-LESS NA; Three phase er with sensorless method (no speed rol)		2023-06-08 PHM		РНМ	150.0		mg	Each		
Ianufacturing P	roccess Information	1													
Terminal P	Terminal Plating / Grid Array Material		Γerminal Base Alloy J-STI		-STD-020 MSL Rating	5	Peak Process Body Temper		emperatu	ture Max Time at Peak Tempe		ature Num	ber of Reflow Cy	eles	
contains Bi		C	CU Alloy 3		-		260 C		C	30	seco	onds 3			
omments															
TTENTION: MSL	3 Rated item requires Ba	ke and D	ry Pack (after	electrical test)											
or more information	regarding material com	position 1	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
cadmium, hexavalentchromium, polybromin contains a RoHS restricted substance inexce encompass all such components. Supplier cet as of the date that Supplier completes this Company acknowledges that Supplier may hindependently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated diphess of an applicable quantity limit, please indriffes that it gathered the information it provom. Supplier acknowledges that Company wave relied on informationprovided by others of the supplier agrees that, at a minimusy and the Supplier enter into a written agree yesource of the Supplier's liability and the C	enyl ethers (each a "RoHS restricted substan licate below which, if any, RoHS exemption vides in this form using appropriate methods vill rely on this certification in determining the s in completing this form, and that Supplier um, itssuppliers have provided certifications ement with respect to the identified part, the tompany's remedies for issues that arise rega	s of the European Union member states) of the ce") in excess of the applicable quantity limit is you believe may apply. If the part is an assemb to ensure its accuracy and that such informatio e compliance of its products with European Ur may not have independently verified such infor regarding their contributions to the part, and the erms and conditions of that agreement, including information the Supplier provides in this	dentified above. If a ally with lower level in is true and correct tion member state la mation. However, in ose certifications are ag any warranty righ	homogeneous material within the part components, the declaration shall to the best of its knowledge and belief, was that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the lats and/or remedies provided as part of						
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	ial Weight Unit of Measure Level Substance		Substance	CAS	Exempt	Weight	Unit of Measure	
Die	5.12	mg	Supplier	Silicon (Si)	7440-21-3		5.0821	mg
			Supplier	Polyimide	Proprietary Data		0.0379	mg
Die Attach	1.27	mg	Supplier	Silver (Ag)	7440-22-4		0.8641	mg
			Supplier	Epoxy resins	129915-35-1		0.3673	mg
			Supplier	Other Metal Oxide	Proprietary Data		0.0277	mg
			В	Antimony Pentoxide (Sb2O5)	1314-60-9		0.0109	mg
Lead Frame	49.21	mg	Supplier	Zinc (Zn)	7440-66-6		0.0935	mg
			Supplier	Iron (Fe)	7439-89-6		1.2745	mg
			Supplier	Copper (Cu)	7440-50-8		47.7731	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0689	mg
Mold Compound-Black	92.25	mg		Epoxy Phenol Resin	proprietary data		11.07	mg
			Supplier	Carbon Black (C)	1333-86-4		0.369	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		78.0435	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		2.7675	mg
Plating	1.7	mg	В	Bismuth (Bi)	7440-69-9		0.0102	mg
			Supplier	Tin (Sn)	7440-31-5		1.6898	mg
Wire Bond - Au	0.45	mg	Supplier	Gold (Au)	7440-57-5		0.45	mg